

Typical Performance Properties

CMC ⁴	480
Surface Tension ⁵	30

⁴ Critical micelle concentration: ppm at 25°C

⁵ Surface tension: dynes/cm at 1% actives, 25°C

Solubility and Compatibility

- Soluble in water
- Soluble in chlorinated solvents and most polar organic solvents
- Chemically stable in the presence of dilute acids, bases and salts
- Compatible with anionic, cationic, and other nonionic surfactants

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